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# FCH25N60N

## N-Channel SupreMOS® MOSFET

600 V, 25 A, 126 mΩ

### Features

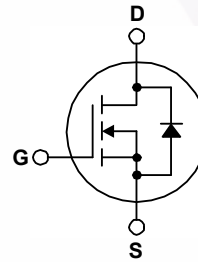
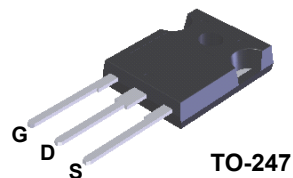
- $R_{DS(on)} = 108 \text{ m}\Omega$  (Typ.) @  $V_{GS} = 10 \text{ V}$ ,  $I_D = 12.5 \text{ A}$
- Ultra Low Gate Charge (Typ.  $Q_g = 57 \text{ nC}$ )
- Low Effective Output Capacitance (Typ.  $C_{oss(eff.)} = 262 \text{ pF}$ )
- 100% Avalanche Tested
- RoHS Compliant

### Application

- Solar Inverter
- AC-DC Power Supply

### Description

The SupreMOS® MOSFET is Fairchild Semiconductor's next generation of high voltage super-junction (SJ) technology employing a deep trench filling process that differentiates it from the conventional SJ MOSFETs. This advanced technology and precise process control provides lowest  $R_{sp}$  on-resistance, superior switching performance and ruggedness. SupreMOS MOSFET is suitable for high frequency switching power converter applications such as PFC, server/telecom power, FPD TV power, ATX power, and industrial power applications.



### MOSFET Maximum Ratings $T_C = 25^\circ\text{C}$ unless otherwise noted.

| Symbol         | Parameter  | FCH25N60N                                  | Unit             |
|----------------|--|--|------------------|
| $V_{DSS}$      | Drain to Source Voltage  | 600  | V                |
| $V_{GSS}$      | Gate to Source Voltage   | $\pm 30$                                   | V                |
| $I_D$          | Drain Current  | - Continuous ( $T_C = 25^\circ\text{C}$ )  | 25               |
|                |  | - Continuous ( $T_C = 100^\circ\text{C}$ ) | 16               |
| $I_{DM}$       | Drain Current  | - Pulsed (Note 1)                          | 75               |
| $E_{AS}$       | Single Pulsed Avalanche Energy                                       | (Note 2)                                   | 861              |
| $I_{AR}$       | Avalanche Current  | (Note 1)                                   | 8.3              |
| $E_{AR}$       | Repetitive Avalanche Energy  | (Note 1)                                   | 2.2              |
| dv/dt          | MOSFET dv/dt   |  | 100              |
|                | Peak Diode Recovery dv/dt  | (Note 3)                                   | 20               |
| $P_D$          | Power Dissipation  | ( $T_C = 25^\circ\text{C}$ )               | 216              |
|                |  | - Derate Above $25^\circ\text{C}$          | 1.72             |
| $T_J, T_{STG}$ | Operating and Storage Temperature Range                              | -55 to +150                                | $^\circ\text{C}$ |
| $T_L$          | Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds | 300  | $^\circ\text{C}$ |

### Thermal Characteristics

| Symbol          | Parameter                                     | FCH25N60N | Unit                      |
|-----------------|---|-----------|---------------------------|
| $R_{\theta JC}$ | Thermal Resistance, Junction to Case, Max.    | 0.58      | $^\circ\text{C}/\text{W}$ |
| $R_{\theta JA}$ | Thermal Resistance, Junction to Ambient, Max. | 40        |                           |

## Package Marking and Ordering Information

| Part Number | Top Mark  | Package | Packing Method | Reel Size | Tape Width | Quantity |
|-------------|-----------|---------|----------------|-----------|------------|----------|
| FCH25N60N   | FCH25N60N | TO-247  | Tube           | N/A       | N/A        | 30 units |

## Electrical Characteristics $T_C = 25^\circ\text{C}$ unless otherwise noted.

| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Unit |
|--------|-----------|-----------------|------|------|------|------|
|--------|-----------|-----------------|------|------|------|------|

### Off Characteristics

|                                |   |  |     |      |           |                    |
|--------------------------------|---|--|-----|------|-----------|--------------------|
| $BV_{DSS}$                     | Drain to Source Breakdown Voltage         | $I_D = 1\text{ mA}, V_{GS} = 0\text{ V}, T_J = 25^\circ\text{C}$ | 600 | -    | -         | V                  |
| $\Delta BV_{DSS} / \Delta T_J$ | Breakdown Voltage Temperature Coefficient | $I_D = 1\text{ mA}$ , Referenced to $25^\circ\text{C}$           | -   | 0.74 | -         | $V/^\circ\text{C}$ |
| $I_{DSS}$                      | Zero Gate Voltage Drain Current           | $V_{DS} = 480\text{ V}, V_{GS} = 0\text{ V}$                     | -   | -    | 10        | $\mu\text{A}$      |
|                                |   | $V_{DS} = 480\text{ V}, T_J = 125^\circ\text{C}$                 | -   | -    | 100       |                    |
| $I_{GSS}$                      | Gate to Body Leakage Current              | $V_{GS} = \pm 30\text{ V}, V_{DS} = 0\text{ V}$                  | -   | -    | $\pm 100$ | nA                 |

### On Characteristics

|              |                                      |   |     |       |       |          |
|--------------|--------------------------------------|---|-----|-------|-------|----------|
| $V_{GS(th)}$ | Gate Threshold Voltage               | $V_{GS} = V_{DS}, I_D = 250\ \mu\text{A}$   | 2.0 | -     | 4.0   | V        |
| $R_{DS(on)}$ | Static Drain to Source On Resistance | $V_{GS} = 10\text{ V}, I_D = 12.5\text{ A}$ | -   | 0.108 | 0.126 | $\Omega$ |

### Dynamic Characteristics

|                 |                                    |  |   |      |      |          |
|-----------------|------------------------------------|--|---|------|------|----------|
| $C_{iss}$       | Input Capacitance                  | $V_{DS} = 100\text{ V}, V_{GS} = 0\text{ V}, f = 1\text{ MHz}$                 | - | 2520 | 3352 | pF       |
| $C_{oss}$       | Output Capacitance                 |  | - | 103  | 137  | pF       |
| $C_{rss}$       | Reverse Transfer Capacitance       |  | - | 3.2  | 5    | pF       |
| $C_{oss}$       | Output Capacitance                 | $V_{DS} = 380\text{ V}, V_{GS} = 0\text{ V}, f = 1\text{ MHz}$                 | - | 55   | -    | pF       |
| $C_{oss(eff.)}$ | Effective Output Capacitance       | $V_{DS} = 0\text{ V to } 480\text{ V}, V_{GS} = 0\text{ V}$                    | - | 262  | -    | pF       |
| $Q_{g(tot)}$    | Total Gate Charge at 10V           | $V_{DS} = 380\text{ V}, I_D = 12.5\text{ A}, V_{GS} = 10\text{ V}$<br>(Note 4) | - | 57   | 74   | nC       |
| $Q_{gs}$        | Gate to Source Gate Charge         |  | - | 10   | -    | nC       |
| $Q_{gd}$        | Gate to Drain "Miller" Charge      |  | - | 18   | -    | nC       |
| ESR             | Equivalent Series Resistance (G-S) | $f = 1\text{ MHz}$   | - | 1    | -    | $\Omega$ |

### Switching Characteristics

|              |                     |   |   |    |     |    |
|--------------|---------------------|---|---|----|-----|----|
| $t_{d(on)}$  | Turn-On Delay Time  | $V_{DD} = 380\text{ V}, I_D = 12.5\text{ A}, V_{GS} = 10\text{ V}, R_G = 4.7\ \Omega$<br>(Note 4) | - | 21 | 52  | ns |
| $t_r$        | Turn-On Rise Time   |   | - | 22 | 54  | ns |
| $t_{d(off)}$ | Turn-Off Delay Time |   | - | 68 | 146 | ns |
| $t_f$        | Turn-Off Fall Time  |   | - | 5  | 20  | ns |

### Drain-Source Diode Characteristics

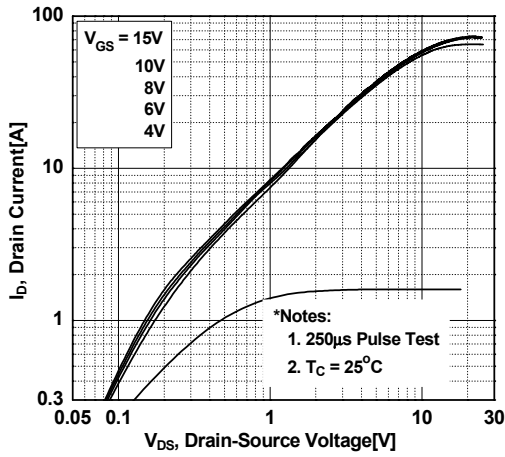
|          |  |   |   |     |     |               |
|----------|--|---|---|-----|-----|---------------|
| $I_S$    | Maximum Continuous Drain to Source Diode Forward Current | -   | - | 25  | A   |               |
| $I_{SM}$ | Maximum Pulsed Drain to Source Diode Forward Current     | -   | - | 75  | A   |               |
| $V_{SD}$ | Drain to Source Diode Forward Voltage                    | $V_{GS} = 0\text{ V}, I_{SD} = 12.5\text{ A}$                                     | - | -   | 1.2 | V             |
| $t_{rr}$ | Reverse Recovery Time                                    | $V_{GS} = 0\text{ V}, I_{SD} = 12.5\text{ A}, dI_F/dt = 100\text{ A}/\mu\text{s}$ | - | 370 | -   | ns            |
| $Q_{rr}$ | Reverse Recovery Charge                                  |   | - | 7   | -   | $\mu\text{C}$ |

#### Notes:

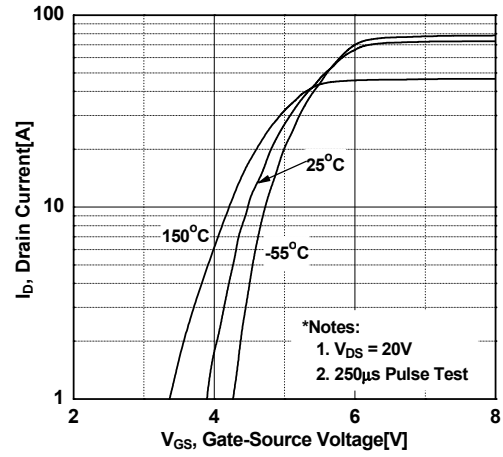
1. Repetitive rating: pulse-width limited by maximum junction temperature.
2.  $I_{AS} = 8.3\text{ A}, R_G = 25\ \Omega$ , starting  $T_J = 25^\circ\text{C}$ .
3.  $I_{SD} \leq 25\text{ A}, di/dt \leq 200\text{ A}/\mu\text{s}, V_{DD} \leq 380\text{ V}$ , starting  $T_J = 25^\circ\text{C}$ .
4. Essentially independent of operating temperature typical characteristics.

## Typical Performance Characteristics

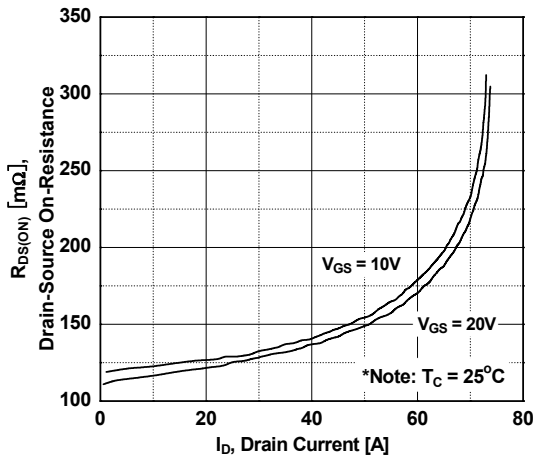
**Figure 1. On-Region Characteristics**



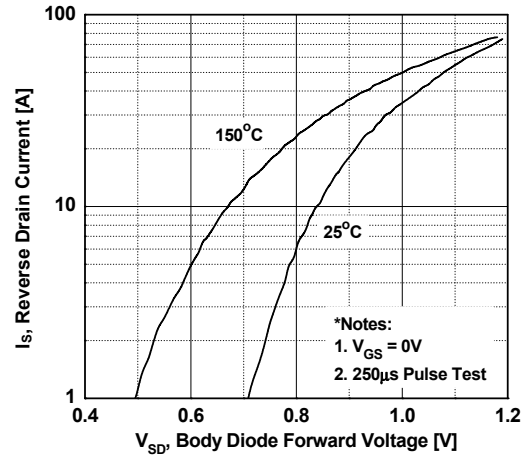
**Figure 2. Transfer Characteristics**



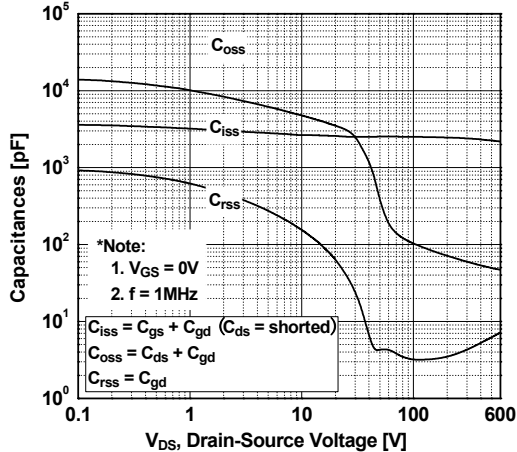
**Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage**



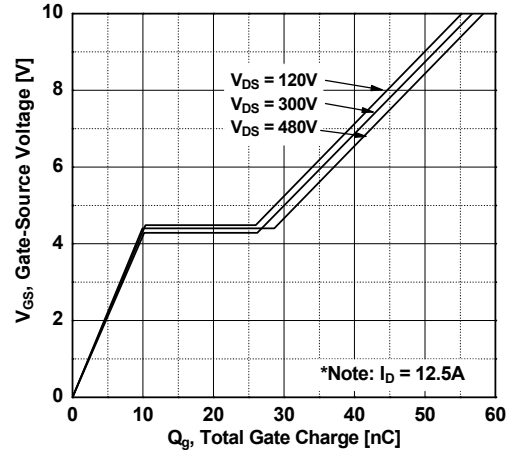
**Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature**



**Figure 5. Capacitance Characteristics**

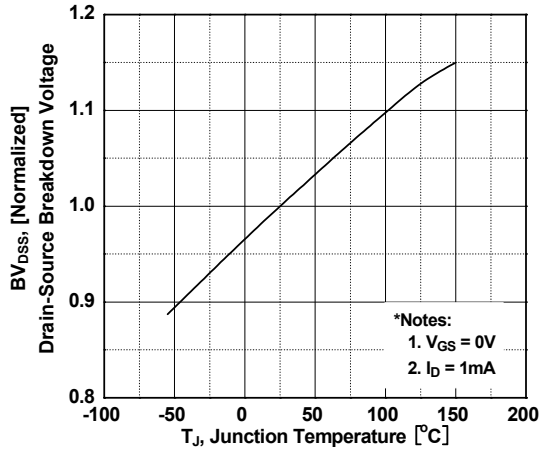


**Figure 6. Gate Charge Characteristics**

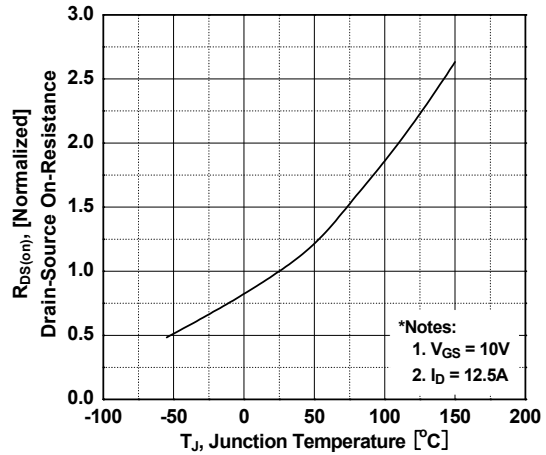


**Typical Performance Characteristics** (Continued)

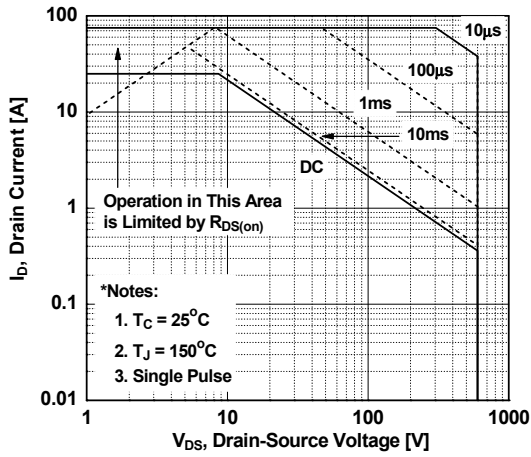
**Figure 7. Breakdown Voltage Variation vs. Temperature**



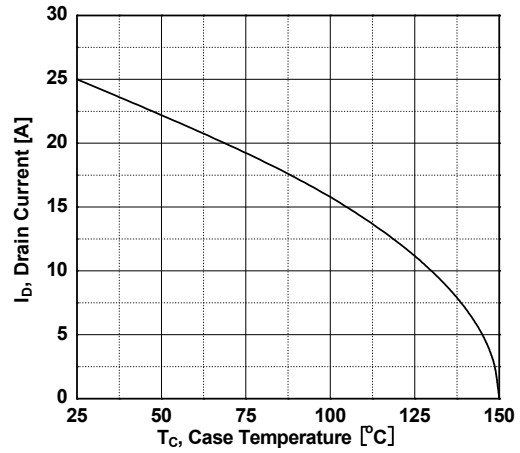
**Figure 8. On-Resistance Variation vs. Temperature**



**Figure 9. Maximum Safe Operating Area**



**Figure 10. Maximum Drain Current vs. Case Temperature**



**Figure 11. Transient Thermal Response Curve**

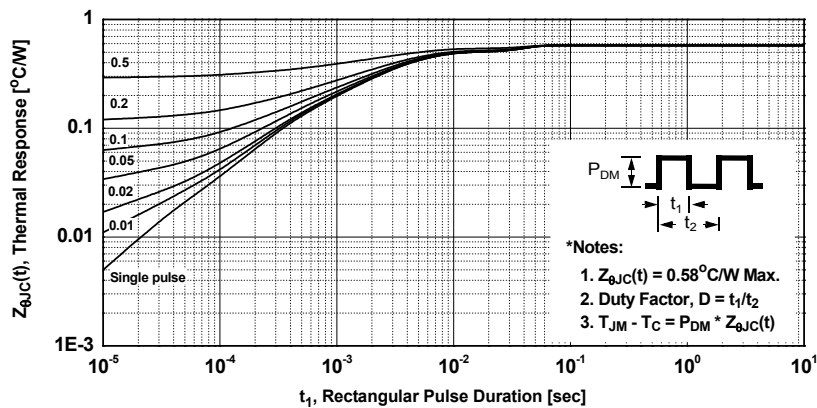




Figure 12. Gate Charge Test Circuit & Waveform



Figure 13. Resistive Switching Test Circuit & Waveforms

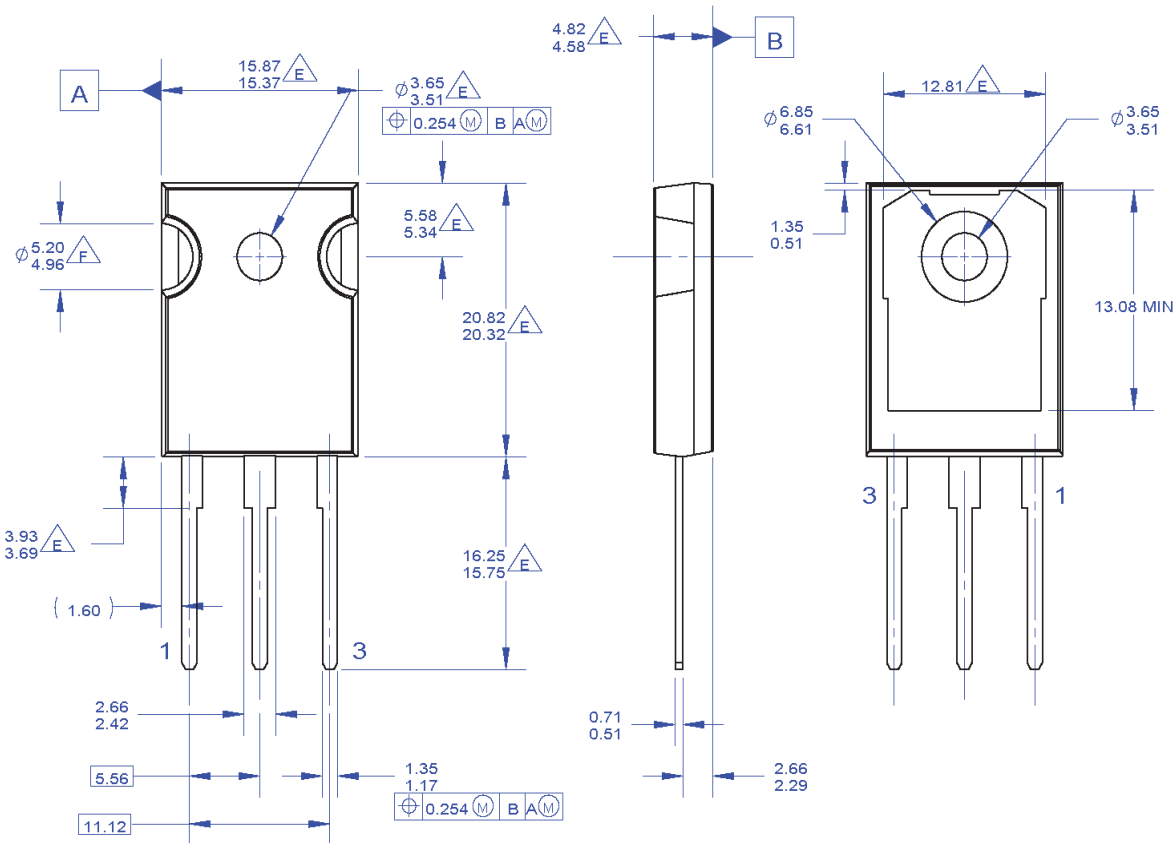


Figure 14. Unclamped Inductive Switching Test Circuit & Waveforms



Figure 15. Peak Diode Recovery  $dv/dt$  Test Circuit & Waveforms

## Mechanical Dimensions



NOTES: UNLESS OTHERWISE SPECIFIED.

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- B. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.
- C. ALL DIMENSIONS ARE IN MILLIMETERS.
- D. DRAWING CONFORMS TO ASME Y14.5 - 1994

$\triangle E$  DOES NOT COMPLY JEDEC STANDARD VALUE

$\triangle F$  NOTCH MAY BE SQUARE

G. DRAWING FILENAME: MKT-TO247A03\_REV03

**Figure 16. TO-247, Molded, 3-Lead, Jedec Variation AB**

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|                          |   |                  |
|                          | PowerTrench®                                    |                  |
|                          | PowerXS™  |                  |
|                          | Programmable Active Droop™                      |                  |
|                          | QFET®   |                  |
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|                          | SyncFET™  |                  |

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